

Chemistry

Physical & Theoretical Chemistry fields

Okayama University

Year 1999

Electrodeposition of Zinc-SiO₂ composite

Kazuo Kondo
Okayama University

Atsufumi Ohgishi
Okayama University

Zennosuke Tanaka
Okayama University

This paper is posted at eScholarship@OUDIR : Okayama University Digital Information Repository.

<http://escholarship.lib.okayama-u.ac.jp/physical.and.theoretical.chemistry/12>

Electrodeposition of Zinc-SiO₂ Composite

Kazuo Kondo,^{*,z} Atsufumi Ohgishi, and Zennosuke Tanaka

Faculty of Engineering, University of Okayama, 3-1-1 Tsushima-Naka, Okayama 700-0082, Japan

The incorporation mechanism of SiO₂ particles into zinc electrodeposit is discussed. The SiO₂ particles precipitate in two ways on the (00·1)_η of zinc electrodeposit: by lined up particles along the laterally growing macrosteps on the (00·1)_η and by randomly dispersed particles on the (00·1)_η. These particles incorporate into the electrodeposits by following two processes. The sidewalls of particles are incorporated into the macrosteps at the edge of (00·1)_η. The bottom of randomly dispersed particles are incorporated into the (00·1)_η probably by the atomic steps.

© 2000 The Electrochemical Society. S0013-4651(99)12-094-9. All rights reserved.

Manuscript submitted December 27, 1999; revised manuscript received March 30, 2000.

Zinc and zinc alloy electrodeposited steel sheets have been used for automobile bodies due to their high corrosion resistance. Zinc electrodeposit composite with SiO₂ or Al₂O₃ particles is known to show good corrosion resistance and paint ability. For example, Hiramatsu *et al.*^{1,2} have reported an improvement in corrosion resistance and paint ability of zinc electrodeposit composite with SiO₂ particles treated with silane coupling. Aslanidis *et al.*³ also have reported an improvement in corrosion resistance and paint ability of zinc electrodeposit if the SiO₂ particle surfaces were covered with titania. Guglielmi⁴ reported the two-step absorption mechanism of the composite particles. The inclusion process of the composite particles is important for understanding the adhesion mechanism between the electrodeposit and painted film. No report so far has been published on this inclusion process.

The author, K.K., has reported on the crystal growth of zinc and zinc alloy electrodeposits.⁵⁻⁸ The hexagonal columnar crystals are composed of the hexagonal plates thin in the *c* axis direction. By atomic force microscopy (AFM) studies, the author reported the growth on the hexagonal plates of these hexagonal columnar crystals.⁹⁻¹¹ The (00·1)_η of pure zinc electrodeposit consists of numerous 30 nm granular crystals and the alignments of these granular crystals form macrosteps.⁹ For the zinc-iron electrodeposit, the (00·1)_η consists of fish scale crystals and the edges of these fish scale crystals are the macrosteps.¹⁰ For the zinc-nickel electrodeposit, the (00·1)_η also consists of fish scale crystals, which are the edges of hexagonal plates. The macrostep heights of the hexagonal plates are 3 nm, which corresponds to about 20 zinc atoms.¹¹

Zinc and zinc alloy electrodeposits grow with the lateral macrosteps on the (00·1)_η of hexagonal columnar crystals. In this report, the incorporation mechanism of SiO₂ particles into these lateral zinc macro steps is discussed.

Experimental

Table I shows the bath composition. The concentration of ZnSO₄ was 1.4 × 10³ mol m⁻³ and that of Na₂SO₄ was 0.53 × 10³ mol m⁻³. Additive of 2.81 × 10⁻³ mol m⁻³ of Sn²⁺ and 0.3 × 10³ g m⁻³ of colloidal silica (Snowtex-OL from Nissan Chemical Industrial, Ltd.) were added. Table II lists the condition for the electrode-

position. The current density was 3000 A m⁻². The bath temperature was kept at 323 K at 2.0 pH. The bath was agitated by a stirrer with string rate of 13.3 rps. The substrate was a commercial low carbon steel 0.8 mm thick. Prior to electrodeposition, the cathode was degreased in acetone with ultrasonic cleaning for 15 min, pickled with 10 vol % sulfuric acid, and rinsed in deionized water. The platinum anode was located 10 mm apart from the cathode. The deposition time was 10 s.

The morphology of deposits was examined by scanning electron microscopy (SEM, Hitachi S-4500) and AFM (Digital Instruments Nano Scope III). The AFM was operated in contact mode using a single-crystal cantilever of Si₃N₄ (NP-S). The crystal structure was analyzed by X-ray diffraction (XRD, Rigaku RAD-2VC) of 40 kV and 30 mA.

Results

SEM observation and XRD.—Figure 1 is the top SEM view of zinc-SiO₂ composite electrodeposit with Sn²⁺ as additive. The hexagonal plane crystals of about 1.0 μm diam become parallel to the substrate. The SiO₂ particles of about 50 nm diam white particles precipitate on these hexagonal plane crystals.

These SiO₂ particles precipitate in two ways on this plane. The one is lined up particles along a macrostep (Fig. 1, larger arrow). The other is randomly dispersed SiO₂ particles on the plane. These hexagonal plane crystals form hexagonal columnar crystals.⁵⁻⁸ At the edge of these hexagonal columnar crystals, the hexagonal plane crystals form a layer-by-layer stacking.

Figure 2 is the result of XRD of this zinc-SiO₂ composite electrodeposit. The (00·2)_η diffraction has the strongest intensity. This strongest intensity indicates that the electrodeposit has a *c* axis orientation and the hexagonal plane crystals are the (00·1)_η plane. The diffraction of the SiO₂ particles does not exist, since the particles are amorphous.

Magnified SEM and AFM observations.—Figure 3 is the magnified SEM micrograph along the macrostep on the (00·1)_η. This macrostep is located close to the edges of the (00·1)_η plate. The SiO₂ particles line up along this macrostep and furthermore, all these particles are incorporated into the sidewall of this macrostep. These incorporated particles are also indicated with smaller arrows in Fig. 1 of the SEM top view.

Figure 4 again is an AFM image along the macrostep on the (00·1)_η. A line is drawn on the surface plot of Fig. 4a. The section analysis along a line on the surface plot is shown in Fig. 4b. The

* Electrochemical Society Active Member.

^z E-mail: kondo@cc.okayama-u.ac.jp

Table I. Bath composition

	Concentrations
ZnSO ₄	1.4 × 10 ³ mol m ⁻³
Na ₂ SO ₄	0.53 × 10 ³ mol m ⁻³
SnSO ₄	2.81 × 10 ⁻³ mol m ⁻³
SiO ₂	0.3 × 10 ³ g m ⁻³

Table II. Condition for the electrodeposition.

Stirring rate	13.3 rps
pH	2.0
Bath temperature	323 K
Current density	3000 A m ⁻²
Deposit time	10 s

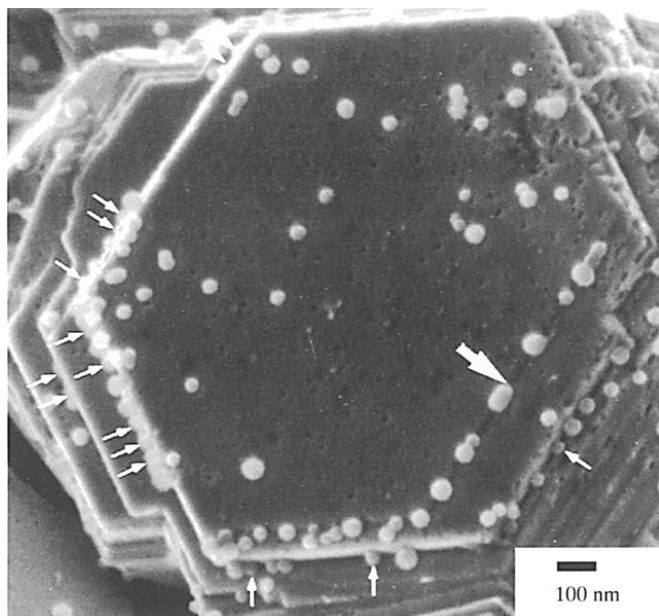


Figure 1. Top-view micrograph of zinc-SiO₂ composite electrodeposit.

height difference between smaller arrows measures the SiO₂ particle diameter and that between larger arrows measures the macrostep height. The section analysis shows that the SiO₂ particles have diameter of 50 nm and the height of the macrostep which incorporates these particles is about 100 nm.

SEM observation with stage tilting.—Figure 5 is the *c* axis orientation electrodeposit with tilting the SEM stage. The micrograph shows the laterally growing macrostep on the (00·1)_η. These SiO₂ particles precipitate in two ways, the randomly dispersed particles and the lined-up particles along the macrostep. The bottoms of the randomly dispersed particles are incorporated into the (00·1)_η plane (Fig. 5, arrows). The bottoms of lined-up particles along the macrosteps, however, are not incorporated into the (00·1)_η.

Figure 6 is the fractured surface of the electrodeposit. The fractured surface shows that the SiO₂ particles are incorporated into the inside of the electrodeposit.

Discussion

The SiO₂ particles line up along the macrosteps on the (00·1)_η plane (Fig. 1, larger arrow). These particles start to be incorporated into the sidewalls of the macrosteps when the macrosteps reach close to the edge of the (00·1)_η (Fig. 1, smaller arrow, Fig. 3). These par-

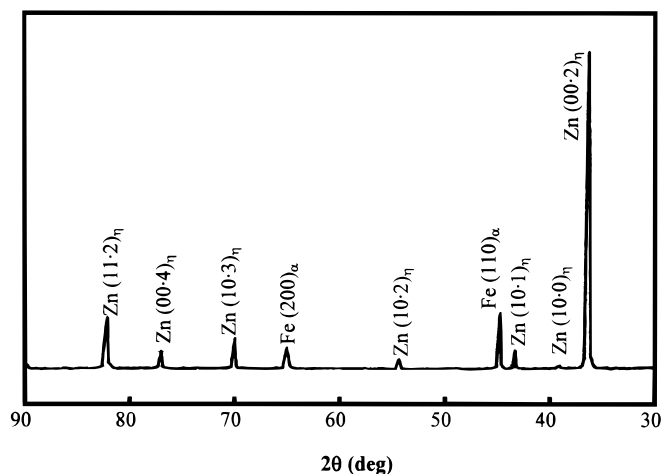


Figure 2. XRD of zinc-SiO₂ composite electrodeposit.

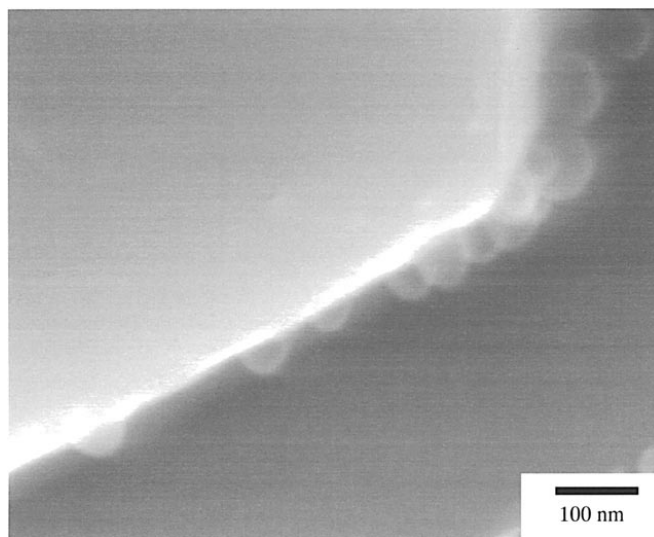


Figure 3. Top-view micrograph along macrostep of the (00·1)_η.

ticles, at the same time, randomly disperse on the (00·1)_η. The bottoms of these randomly dispersed particles are incorporated into the (00·1)_η (Fig. 5, arrows). The bottoms of the lined-up particles along

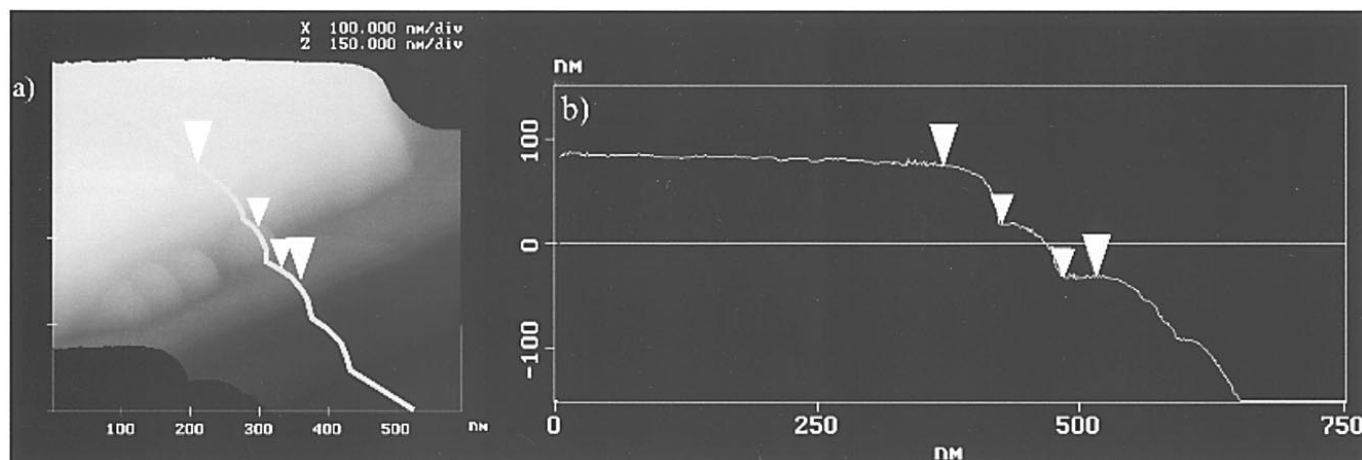


Figure 4. AFM image along the macrostep on the (00·1)_η: (a) surface plot and (b) section analysis.

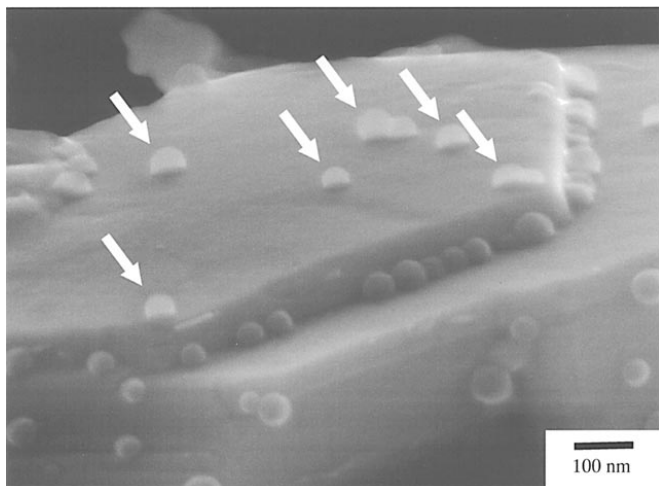


Figure 5. Side-view micrograph of zinc-SiO₂ composite electrodeposit.

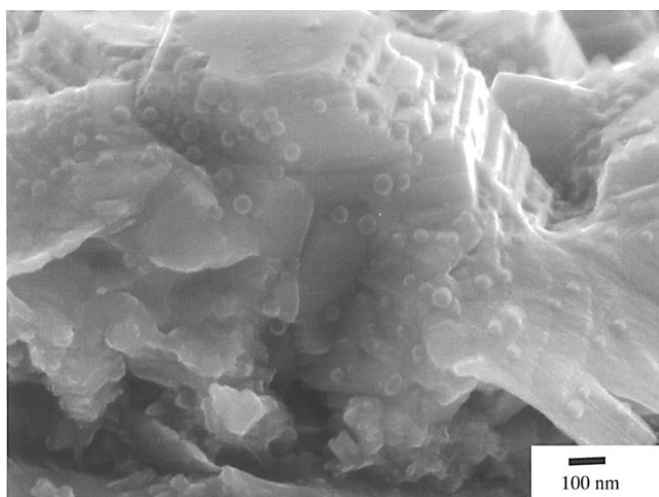


Figure 6. Fractured surface of electrodeposit.

the macrosteps, however, are not incorporated into the (00·1)_η (Fig. 5).

The zinc electrodeposit incorporates SiO₂ particles in two ways. The particles line up along the macrosteps. The macrosteps grow laterally and sweep up the particles to the (00·1)_η edge. The particles are eventually incorporated into the macrostep sidewalls at the (00·1)_η edge (Fig. 7). The randomly dispersed particles remain at their adsorbed sites. The lower portions of these randomly dispersed

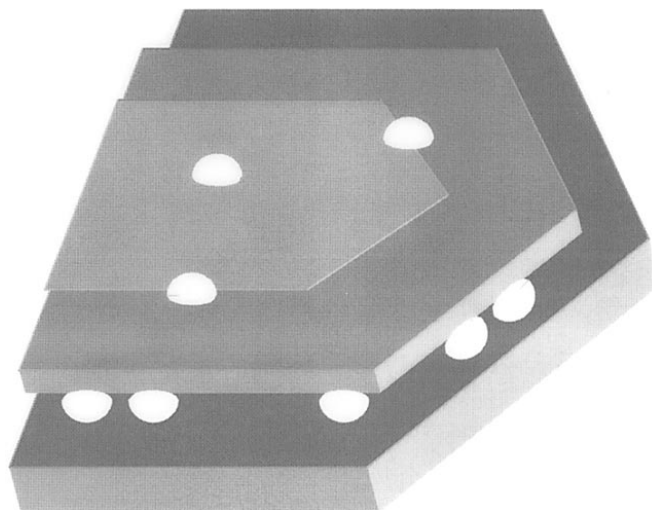


Figure 7. Incorporation mechanism.

particles are incorporated into the (00·1)_η. The atomic steps are thought to incorporate these randomly dispersed particles (Fig. 7).

Conclusions

The SiO₂ particles precipitate in two ways on the (00·1)_η: by lined-up particles along the laterally growing macrosteps and by randomly dispersed SiO₂ particles on the (00·1)_η. These particles incorporate into the electrodeposit by the following two processes.

1. The particles line up along the laterally growing macrosteps. These particles must be incorporated into the macrostep sidewalls at this edge of (00·1)_η.
2. The randomly dispersed particles are incorporated into the (00·1)_η from their bottoms probably by the atomic steps.

Acknowledgments

Part of this research was supported by the Iron and Steel Institute, Japan.

The University of Okayama assisted in meeting the publication costs of this article.

References

1. M. Hiramatsu and H. Kawasaki, *Hyoumen-gijitu*, **40**, 406 (1989).
2. M. Hiramatsu, H. Kawasaki, T. Omi, and Y. Nakayama, *Hyoumen-gijitu*, **38**, 12 (1987).
3. D. Aslanidis, J. Fransaer, and J.-P. Celis, *J. Electrochem. Soc.*, **144**, 2352 (1997).
4. N. Guglielmi, *J. Electrochem. Soc.*, **119**, 1009 (1972).
5. K. Kondo, *Tetsu-to-Hagane*, **74**, 2300 (1988).
6. K. Kondo, *ISIJ Int.*, **29**, 517 (1989).
7. K. Kondo, Ph.D. Thesis, Kyoto University, Kyoto, Japan (Jan 1994).
8. K. Kondo, *Tetsu-to-Hagane*, **76**, 592 (1990).
9. K. Kondo, T. Murakami, F. Cerwinski, and K. Shinohara, *ISIJ Int.*, **37**, 140 (1997).
10. F. Czerwinski, K. Kondo, and J. A. Szpunar, *J. Electrochem. Soc.*, **144**, 481 (1997).
11. K. Kondo and Z. Tanaka, *ISIJ Int.*, **38**, 778 (1998).